

DOCKET NO: 288839US0PCT

IN THE UNITED STATES PATENT & TRADEMARK OFFICE

IN RE APPLICATION OF :
EKKEHARD MUEH, ET AL. : EXAMINER: J.A. MILLER, JR.
SERIAL NO: 10/586,675 :
FILED: JULY 20, 2006 : GROUP ART UNIT: 1715
FOR: SILICON COMPOUNDS FOR PRODUCING SIO₂-CONTAINING INSULATING
LAYERS ON CHIPS

AMENDMENT AND REQUEST FOR RECONSIDERATION

COMMISSIONER FOR PATENTS
ALEXANDRIA, VIRGINIA 22313

SIR:

Responsive to the Office Action dated March 14, 2011, Applicants respectfully request reconsideration of the above-identified application in view of the following amendments and remarks:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

A discussion of the **Support for the Amendments** begins on page 5 of this paper.

Remarks begin on page 6 of this paper.

DO NOT ENTER: /J.M./

06/17/2011

ALL REFERENCES CONSIDERED EXCEPT WHERE LINED THROUGH. /J.M./